

Supplementary Material

Self-Healing in Mobility-Restricted Conditions Maintaining Mechanical Robustness: Furan- Maleimide Diels-Alder Cycloadditions in Polymer Networks for Ambient Applications

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Table S1 Kinetic and thermodynamic parameters from [40].

Kinetic/thermodynamic parameters	Parameter values
$\ln(A_{DA,endo})$ (kg mol ⁻¹ s ⁻¹)	13.4
$E_{DA,endo}$ (kJ mol ⁻¹)	59.4
$\ln(k_{DA,endo})$ (s ⁻¹) at 298 K	-10.5
$\ln(A_{rDA,endo})$ (s ⁻¹)	30.9
$E_{rDA,endo}$ (kJ mol ⁻¹)	113.1
$\ln(k_{rDA,endo})$ (s ⁻¹) at 298 K	-14.7
$\ln(A_{DA,exo})$ (kg mol ⁻¹ s ⁻¹)	14.7
$E_{DA,exo}$ (kJ mol ⁻¹)	64.6
$\ln(k_{DA,exo})$ (s ⁻¹) at 298 K	-11.4
$\ln(A_{rDA,exo})$ (s ⁻¹)	31.4
$E_{rDA,exo}$ (kJ mol ⁻¹)	123.6
$\ln(k_{rDA,exo})$ (s ⁻¹) at 298 K	-18.4
$\Delta_r H^0_{endo}$ (kJ mol ⁻¹)	-53.7
$\Delta_r S^0_{endo}$ (J mol ⁻¹ K ⁻¹)	-145.1
$\Delta_r H^0_{exo}$ (kJ mol ⁻¹)	-59.0
$\Delta_r S^0_{exo}$ (J mol ⁻¹ K ⁻¹)	-138.9

The data of Table S1 are based on furan-maleimide DA reactions where secondary H-bonding interactions by OH-functionalities linked to the furan compounds are involved. They are suitable for the simulation of the cure kinetics of the two thermosetting networks of this paper, for which secondary H-bonding interactions by NH-functionalities linked to the furan compounds are involved.

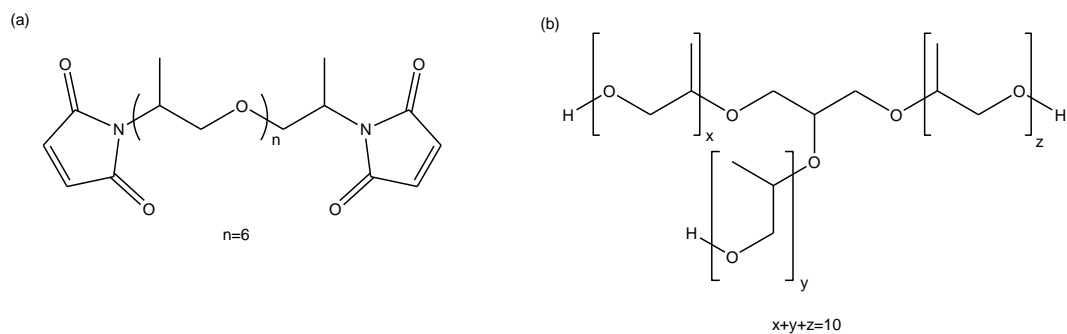


Figure S1. Additional chemical structures of the starting reagents used in Figure S2 to cure model reversible network M400-3F251: (a) amorphous bismaleimide M400 (M_{400} , $M_{eq} = 308 \text{ g mol}^{-1}$, $f=1.95$, Specific Polymers); (b) glycerol-based polyol Daltolac R251 ($M = 673 \text{ g mol}^{-1}$, Huntsman).

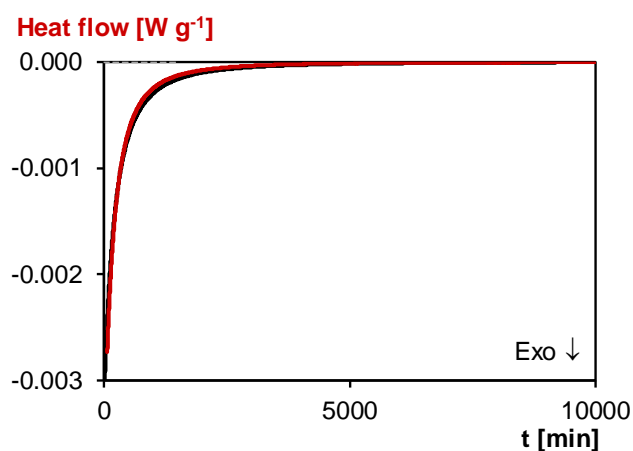


Figure S2. Microcalorimetry and simulated evolution of the normalized heat flow as a function of time at 20 °C of the M400-3F251 model reversible network prepared the same way as the reversible thermosetting network 3M-3F630 (See 2.2 Synthesis of the main text). **Black:** simulated normalized heat flow using data set of Table S1; **Red:** experimental normalized heat flow.

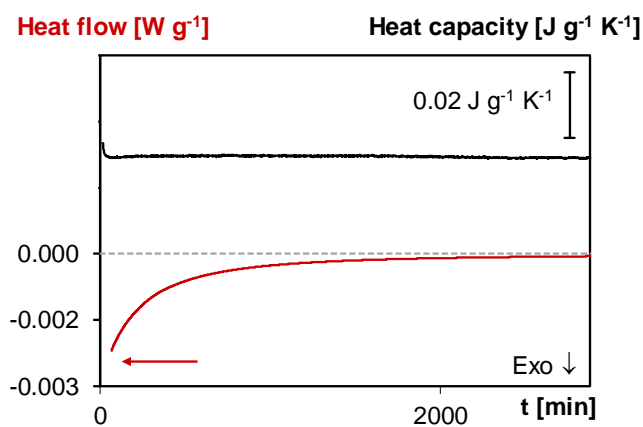


Figure S3. MTDSC and microcalorimetry of 3M-F375PMA at 20 °C. **Black:** (specific) heat capacity as a function of time measured in MTDSC; **Red:** normalized heat flow as a function of time measured in TAM.

The normalized heat flow intensity at the start of the reaction is around 3 times smaller than for 3M-3F630 in the same reaction conditions and the decrease of exothermicity over time is much slower, showing the effect of the concentration on the reaction rate which for 3M-F375MA is about 1.7 times smaller than for 3M-3F630. The c_p evolution of the 3M-F375MA system clearly presents no sudden Δc_p drop typical of vitrification, which shows that the system does not enter a vitrified state during cure at 20 °C.

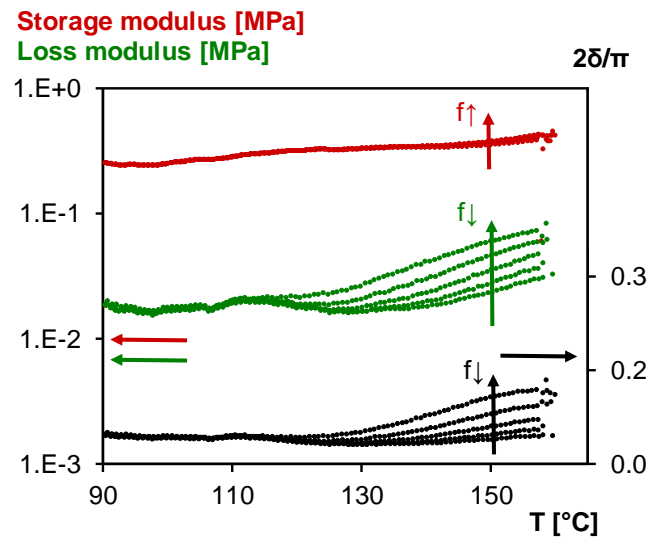


Figure S4. Storage modulus, loss modulus and normalized loss angle of dynamic rheometry during non-isothermal treatment at 0.5 K min^{-1} between 90 °C and 160 °C of previously photo-cured reversible network 3M-F375PMA. **Black:** normalized loss angle; **Red:** storage modulus; **Green:** loss modulus.

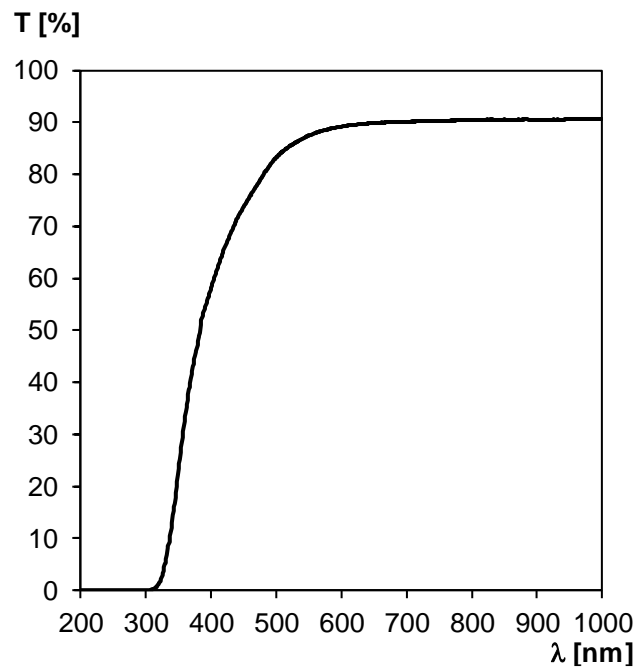


Figure S5. Transmittance determined by means of UV-Vis spectroscopy for a 500 μm thick 3M-F375PMA film. 1000-515 nm: $T > 85\%$, 515-435 nm: $T > 70\%$, UV-cutoff: 315 nm.